SN54ACT533 ... J OR W PACKAGE SN74ACT533 ... DB, DW, N, NS, OR PW PACKAGE

(TOP VIEW)

SCAS553C - NOVEMBER 1995 - REVISED OCTOBER 2002

- 4.5-V to 5.5-V V<sub>CC</sub> Operation
- Inputs Accept Voltages to 5.5 V
- Max t<sub>pd</sub> of 11 ns at 5 V
- Inputs Are TTL-Voltage Compatible
- 3-State Inverting Outputs Drive Bus Lines Directly

#### description/ordering information

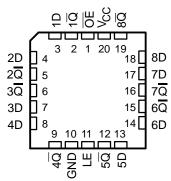
The 'ACT533 devices are octal transparent D-type latches with 3-state outputs. When the latch-enable (LE) input is high, the  $\overline{Q}$  outputs follow the complements of the data (D) inputs. When LE is taken low, the  $\overline{Q}$  outputs are latched at the inverted levels set up at the D inputs.

A buffered output-enable  $(\overline{OE})$  input can be used to place the eight outputs in either a normal logic state (high or low logic levels) or the high-impedance state. In the high-impedance state, the outputs neither load nor drive the bus lines significantly. The high-impedance state and increased drive provide the capability to drive bus lines without need for interface or pullup components.

 $\overline{OE}$  does not affect the internal operations of the latches. Old data can be retained or new data can be entered while the outputs are in the high-impedance state.

| OE<br>1Q<br>1D<br>2D | 3<br>4 | 18<br>17 | ] V <sub>CC</sub><br>] 8Q<br>] 8D<br>] 7 <u>D</u> |
|----------------------|--------|----------|---|
| 2Q                   | 5      | 16       | ] 7Q  |
| 3 <mark>Q</mark> [   | 6      |          | 6Q  |
| 3D [                 | 7      |          | ] 6D  |
| 4D [                 | 8      | 13       | 5D  |
| 4Q [                 | 9      | 12       | 5Q  |
| GND [                | 10     | 11       | LE  |
|                      |        |          |   |

SN54ACT533 . . . FK PACKAGE (TOP VIEW)



To ensure the high-impedance state during power up or power down,  $\overline{OE}$  should be tied to V<sub>CC</sub> through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

| TA             | PACKAGE      | <u>≡</u> †    | ORDERABLE<br>PART NUMBER | TOP-SIDE<br>MARKING |  |  |  |  |  |  |  |  |
|----------------|--------------|---------------|--------------------------|---------------------|--|--|--|--|--|--|--|--|
| -40°C to 85°C  | PDIP – N     | Tube          | SN74ACT533N              | SN74ACT533N         |  |  |  |  |  |  |  |  |
|                | SOIC - DW    | Tube          | SN74ACT533DW             | ACT533              |  |  |  |  |  |  |  |  |
|                | 3010 - 010   | Tape and reel | SN74ACT533DWR            | AC1555              |  |  |  |  |  |  |  |  |
|                | SOP – NS     | Tape and reel | SN74ACT533NSR            | ACT533              |  |  |  |  |  |  |  |  |
|                | SSOP – DB    | Tape and reel | SN74ACT533DBR            | AD533               |  |  |  |  |  |  |  |  |
|                | TSSOP – PW   | Tape and reel | SN74ACT533PWR            | AD533               |  |  |  |  |  |  |  |  |
|                | CDIP – J     | Tube          | SNJ54ACT533J             | SNJ54ACT533J        |  |  |  |  |  |  |  |  |
| –55°C to 125°C | CFP – W Tube |               | SNJ54ACT533W             | SNJ54ACT533W        |  |  |  |  |  |  |  |  |
|                | LCCC – FK    | Tube          | SNJ54ACT533K             | SNJ54ACT533FK       |  |  |  |  |  |  |  |  |

#### **ORDERING INFORMATION**

<sup>†</sup> Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

UNLESS OTHERWISE NOTED this document contains PRODUCTION DATA information current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.



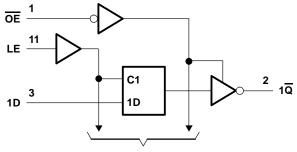
Copyright © 2002, Texas Instruments Incorporated

1

SCAS553C - NOVEMBER 1995 - REVISED OCTOBER 2002

|    | FUNCTION TABLE<br>(each latch) |   |                     |  |  |  |  |  |  |  |  |  |
|----|--------------------------------|---|---------------------|--|--|--|--|--|--|--|--|--|
|    | INPUTS                         |   | OUTPUT              |  |  |  |  |  |  |  |  |  |
| OE | LE                             | Q |                     |  |  |  |  |  |  |  |  |  |
| L  | Н                              | Н | L                   |  |  |  |  |  |  |  |  |  |
| L  | Н                              | L | н                   |  |  |  |  |  |  |  |  |  |
| L  | L                              | Х | Q <sub>0</sub><br>Z |  |  |  |  |  |  |  |  |  |
| Н  | Х                              | Х | Z                   |  |  |  |  |  |  |  |  |  |

#### logic diagram (positive logic)



**To Seven Other Channels** 

#### absolute maximum ratings over operating free-air temperature range (unless otherwise noted)<sup>†</sup>

| ,  |                |
|--|----------------|
|  | ±20 mA         |
| Output clamp current, $I_{OK}$ (V <sub>O</sub> < 0 or V <sub>O</sub> > V <sub>CC</sub> ) | ±20 mA         |
| Continuous output current, $I_O (V_O = 0 \text{ to } V_{CC}) \dots$                      | ±50 mA         |
| Continuous current through V <sub>CC</sub> or GND  | ±200 mA        |
| Package thermal impedance, $\theta_{JA}$ (see Note 2): DB pa                             | nckage         |
| DW p   | ackage 58°C/W  |
| N pac  | kage 69°C/W    |
| NS pa  | nckage 60°C/W  |
| PW pa  | ackage 83°C/W  |
| Storage temperature range, T <sub>stg</sub>  | –65°C to 150°C |

<sup>†</sup> Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

2. The package thermal impedance is calculated in accordance with JESD 51-7.



SCAS553C - NOVEMBER 1995 - REVISED OCTOBER 2002

#### recommended operating conditions (see Note 3)

|                     |                                    | SN54ACT533 |     | SN74A   | CT533 | UNIT |  |
|---------------------|------------------------------------|------------|-----|---------|-------|------|--|
|                     |                                    | MIN        | MAX | MIN MAX |       |      |  |
| VCC                 | Supply voltage                     | 4.5        | 5.5 | 4.5     | 5.5   | V    |  |
| VIH                 | High-level input voltage           | 2          | Ŋ   | 2       |       | V    |  |
| VIL                 | Low-level input voltage            |            | 0.8 |         | 0.8   | V    |  |
| VI                  | Input voltage                      | 0          | Vcc | 0       | VCC   | V    |  |
| Vo                  | Output voltage                     | 0          | Vcc | 0       | VCC   | V    |  |
| ЮН                  | High-level output current          | 202        | -24 |         | -24   | mA   |  |
| IOL                 | Low-level output current           | 30%        | 24  |         | 24    | mA   |  |
| $\Delta t/\Delta v$ | Input transition rise or fall rate | 9          | 8   |         | 8     | ns/V |  |
| TA                  | Operating free-air temperature     | -55        | 125 | -40     | 85    | °C   |  |

NOTE 3: All unused inputs of the device must be held at V<sub>CC</sub> or GND to ensure proper device operation. Refer to the TI application report *Implications of Slow or Floating CMOS Inputs*, literature number SCBA004.

## electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

| DADAMETED       | TEST CONDITIONS   | N     | т    | <b>₄ = 25°C</b> | ;     | SN54A | CT533 | SN74A | CT533 |      |
|-----------------|---|-------|------|-----------------|-------|-------|-------|-------|-------|------|
| PARAMETER       | TEST CONDITIONS   | Vcc   | MIN  | TYP             | MAX   | MIN   | MAX   | MIN   | MAX   | UNIT |
|                 |   | 4.5 V | 4.4  | 4.49            |       | 4.4   |       | 4.4   |       |      |
|                 | I <sub>OH</sub> = -50 μA                                      | 5.5 V | 5.4  | 5.49            |       | 5.4   |       | 5.4   |       |      |
| Vou             | lou - 24 mA   | 4.5 V | 3.86 |                 |       | 3.7   |       | 3.76  |       | V    |
| VOH             | I <sub>OH</sub> = -24 mA                                      | 5.5 V | 4.86 |                 |       | 4.7   |       | 4.76  |       | v    |
|                 | $I_{OH} = -50 \text{ mA}^{\dagger}$                           | 5.5 V |      |                 |       | 3.85  |       |       |       |      |
|                 | $I_{OH} = -75 \text{ mA}^{\dagger}$                           | 5.5 V |      |                 |       |       | h     | 3.85  |       |      |
|                 |   | 4.5 V |      |                 | 0.1   |       | 0.1   |       | 0.1   |      |
|                 | I <sub>OL</sub> = 50 μA                                       | 5.5 V |      |                 | 0.1   |       | 0.1   |       | 0.1   |      |
| Ve              | I <sub>OL</sub> = 24 mA                                       | 4.5 V |      |                 | 0.36  | ~     | 0.5   |       | 0.44  | V    |
| V <sub>OL</sub> | OL = 24 MA  | 5.5 V |      |                 | 0.36  | 20    | 0.5   |       | 0.44  | v    |
|                 | $I_{OL} = 50 \text{ mA}^{\dagger}$                            | 5.5 V |      |                 |       | 202   | 1.65  |       |       |      |
|                 | $I_{OL} = 75 \text{ mA}^{\dagger}$                            | 5.5 V |      |                 |       | 9     |       |       | 1.65  |      |
| I <sub>OZ</sub> | $V_{O} = V_{CC}$ or GND                                       | 5.5 V |      |                 | ±0.25 |       | ±5    |       | ±2.5  | μA   |
| lj              | $V_{I} = V_{CC}$ or GND                                       | 5.5 V |      |                 | ±0.1  |       | ±1    |       | ±1    | μA   |
| ICC             | $V_{I} = V_{CC} \text{ or GND}, \qquad I_{O} = 0$             | 5.5 V |      |                 | 4     |       | 80    |       | 40    | μA   |
| ∆ICC‡           | One input at 3.4 V,<br>Other inputs at GND or V <sub>CC</sub> | 5.5 V |      | 0.6             |       |       | 1.6   |       | 1.5   | mA   |
| Ci              | $V_I = V_{CC}$ or GND   | 5 V   |      | 4.5             |       |       |       |       |       | pF   |

<sup>†</sup> Not more than one output should be tested at a time, and the duration of the test should not exceed 2 ms.

<sup>‡</sup>This is the increase in supply current for each input that is at one of the specified TTL voltage levels, rather than 0 V or V<sub>CC</sub>.

# timing requirements over recommended operating free-air temperature range, V<sub>CC</sub> = 5 V $\pm$ 0.5 V (unless otherwise noted) (see Figure 1)

|                 |   | T <sub>A</sub> = 2 | 25°C | SN54A | CT533 | SN74A | CT533 | UNIT |
|-----------------|---|--------------------|------|-------|-------|-------|-------|------|
|                 |   | MIN                | MAX  | MIN   | MAX   | MIN   | MAX   | UNIT |
| tw              | Pulse duration, LE high                 | 5                  |      | 7.5   | 5.0   | 6     |       | ns   |
| t <sub>su</sub> | Setup time, data before LE $\downarrow$ | 3                  |      | 5.5   | 11r   | 4     |       | ns   |
| t <sub>h</sub>  | Hold time, data after LE $\downarrow$   | 2                  |      | 4     |       | 2.5   |       | ns   |

PRODUCT PREVIEW information concerns products in the formative or design phase of development. Characteristic data and other specifications are design goals. Texas Instruments reserves the right to change or discontinue these products without notice.



SCAS553C - NOVEMBER 1995 - REVISED OCTOBER 2002

# switching characteristics over recommended operating free-air temperature range, $V_{CC}$ = 5 V $\pm$ 0.5 V (unless otherwise noted) (see Figure 1)

| PARAMETER        | FROM    | то       | T <sub>A</sub> = 25°C |      | SN54A | CT533       | SN74A | CT533 | UNIT |
|------------------|---------|----------|-----------------------|------|-------|-------------|-------|-------|------|
| PARAMETER        | (INPUT) | (OUTPUT) | MIN                   | MAX  | MIN   | MAX         | MIN   | MAX   | UNIT |
| <sup>t</sup> PLH | D       | Q        | 2.5                   | 10.5 | 1.5   | 13          | 2     | 11.5  | 20   |
| <sup>t</sup> PHL | D       | Q        | 2.5                   | 10   | 1.5   | 12.5        | 2     | 11    | ns   |
| <sup>t</sup> PLH | LE      | Q        |                       | 10.5 | 1.5   | <b>A</b> 13 | 2     | 11.5  | ns   |
| <sup>t</sup> PHL | LL      | Q        | 2.5                   | 10.5 | 1.5   | 2 13        | 2     | 11.5  | 115  |
| <sup>t</sup> PZH | OE      | Iq       | 2                     | 10   | 0     | 12.5        | 1.5   | 11    | 20   |
| <sup>t</sup> PZL | OE      | ġ        | 2                     | 10   | 201   | 12.5        | 1.5   | 11    | ns   |
| <sup>t</sup> PHZ | OE      | Q        | 2                     | 10   | x 1   | 12.5        | 1.5   | 11    | 20   |
| <sup>t</sup> PLZ | UE      | Q        | 2                     | 10   | 1     | 12.5        | 1.5   | 11    | ns   |

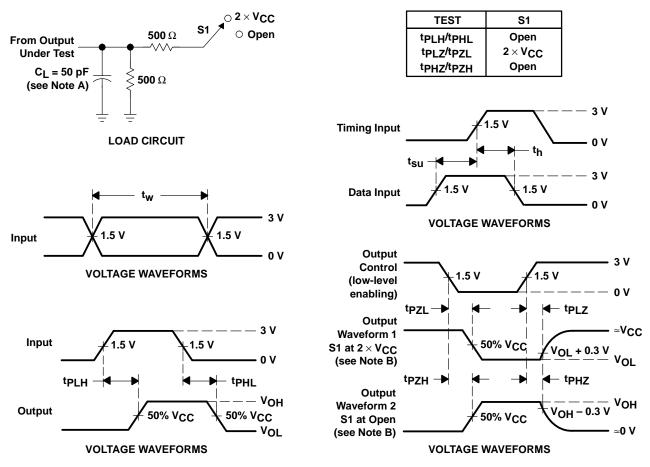
## operating characteristics, $V_{CC}$ = 5 V, $T_A$ = 25°C

| PARAMETER                                     | TEST CONDITIONS                           | TYP | UNIT |
|---|---|-----|------|
| C <sub>pd</sub> Power dissipation capacitance | $C_L = 50 \text{ pF},  f = 1 \text{ MHz}$ | 40  | pF   |

PRODUCT PREVIEW information concerns products in the formative or design phase of development. Characteristic data and other specifications are design goals. Texas Instruments reserves the right to change or discontinue these products without notice.



SCAS553C - NOVEMBER 1995 - REVISED OCTOBER 2002



#### PARAMETER MEASUREMENT INFORMATION

- NOTES: A. CL includes probe and jig capacitance.
  - B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
  - C. All input pulses are supplied by generators having the following characteristics: PRR  $\leq$  1 MHz, Z<sub>Q</sub> = 50  $\Omega$ , t<sub>f</sub>  $\leq$  2.5 ns. t<sub>f</sub>  $\leq$  2.5 ns.
  - D. The outputs are measured one at a time with one input transition per measurement.

#### Figure 1. Load Circuit and Voltage Waveforms





#### PACKAGING INFORMATION

| Orderable Device | Status<br>(1) | Package Type | Package<br>Drawing | Pins | Package<br>Qty | Eco Plan<br>(2) | Lead finish/<br>Ball material | MSL Peak Temp      | Op Temp (°C) | Device Marking<br>(4/5) | Samples |
|------------------|---------------|--------------|--------------------|------|----------------|-----------------|-------------------------------|--------------------|--------------|-------------------------|---------|
|                  |               |              |                    |      |                |                 | (6)                           |                    |              |                         |         |
| SN74ACT533DW     | ACTIVE        | SOIC         | DW                 | 20   | 25             | RoHS & Green    | NIPDAU                        | Level-1-260C-UNLIM | -40 to 85    | ACT533                  | Samples |
| SN74ACT533N      | ACTIVE        | PDIP         | Ν                  | 20   | 20             | RoHS & Green    | NIPDAU                        | N / A for Pkg Type | -40 to 85    | SN74ACT533N             | Samples |
| SN74ACT533PWR    | ACTIVE        | TSSOP        | PW                 | 20   | 2000           | RoHS & Green    | NIPDAU                        | Level-1-260C-UNLIM | -40 to 85    | AD533                   | Samples |

<sup>(1)</sup> The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

<sup>(2)</sup> RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

**RoHS Exempt:** TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (CI) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

<sup>(3)</sup> MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

<sup>(4)</sup> There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

(5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

<sup>(6)</sup> Lead finish/Ball material - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

Important Information and Disclaimer: The information provided on this page represents TI's knowledge and belief as of the date that it is provided. TI bases its knowledge and belief on information provided by third parties, and makes no representation or warranty as to the accuracy of such information. Efforts are underway to better integrate information from third parties. TI has taken and continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.



www.ti.com

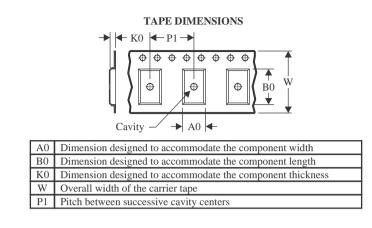
In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.



www.ti.com

### TAPE AND REEL INFORMATION





#### QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



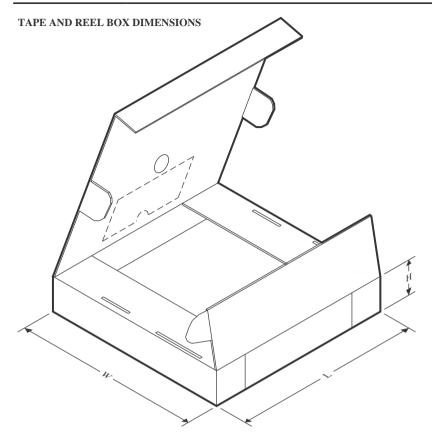
| *All dimensions are nominal |                 |                    |    |      |                          |                          |            |            |            |            |           |                  |
|-----------------------------|-----------------|--------------------|----|------|--------------------------|--------------------------|------------|------------|------------|------------|-----------|------------------|
| Device                      | Package<br>Type | Package<br>Drawing |    | SPQ  | Reel<br>Diameter<br>(mm) | Reel<br>Width<br>W1 (mm) | A0<br>(mm) | B0<br>(mm) | K0<br>(mm) | P1<br>(mm) | W<br>(mm) | Pin1<br>Quadrant |
| SN74ACT533PWR               | TSSOP           | PW                 | 20 | 2000 | 330.0                    | 16.4                     | 6.95       | 7.1        | 1.6        | 8.0        | 16.0      | Q1               |



www.ti.com

## PACKAGE MATERIALS INFORMATION

16-Apr-2024



\*All dimensions are nominal

| Device        | Package Type | Package Drawing | g Pins SPQ |      | Length (mm) | Width (mm) | Height (mm) |  |
|---------------|--------------|-----------------|------------|------|-------------|------------|-------------|--|
| SN74ACT533PWR | TSSOP        | PW              | 20         | 2000 | 356.0       | 356.0      | 35.0        |  |

### TEXAS INSTRUMENTS

www.ti.com

16-Apr-2024

## TUBE



## - B - Alignment groove width

\*All dimensions are nominal

| Device       | Package Name | Package Type | Pins | SPQ | L (mm) | W (mm) | Τ (μm) | B (mm) |
|--------------|--------------|--------------|------|-----|--------|--------|--------|--------|
| SN74ACT533DW | DW           | SOIC         | 20   | 25  | 507    | 12.83  | 5080   | 6.6    |
| SN74ACT533N  | N            | PDIP         | 20   | 20  | 506    | 13.97  | 11230  | 4.32   |

#### IMPORTANT NOTICE AND DISCLAIMER

TI PROVIDES TECHNICAL AND RELIABILITY DATA (INCLUDING DATA SHEETS), DESIGN RESOURCES (INCLUDING REFERENCE DESIGNS), APPLICATION OR OTHER DESIGN ADVICE, WEB TOOLS, SAFETY INFORMATION, AND OTHER RESOURCES "AS IS" AND WITH ALL FAULTS, AND DISCLAIMS ALL WARRANTIES, EXPRESS AND IMPLIED, INCLUDING WITHOUT LIMITATION ANY IMPLIED WARRANTIES OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE OR NON-INFRINGEMENT OF THIRD PARTY INTELLECTUAL PROPERTY RIGHTS.

These resources are intended for skilled developers designing with TI products. You are solely responsible for (1) selecting the appropriate TI products for your application, (2) designing, validating and testing your application, and (3) ensuring your application meets applicable standards, and any other safety, security, regulatory or other requirements.

These resources are subject to change without notice. TI grants you permission to use these resources only for development of an application that uses the TI products described in the resource. Other reproduction and display of these resources is prohibited. No license is granted to any other TI intellectual property right or to any third party intellectual property right. TI disclaims responsibility for, and you will fully indemnify TI and its representatives against, any claims, damages, costs, losses, and liabilities arising out of your use of these resources.

TI's products are provided subject to TI's Terms of Sale or other applicable terms available either on ti.com or provided in conjunction with such TI products. TI's provision of these resources does not expand or otherwise alter TI's applicable warranties or warranty disclaimers for TI products.

TI objects to and rejects any additional or different terms you may have proposed.

Mailing Address: Texas Instruments, Post Office Box 655303, Dallas, Texas 75265 Copyright © 2024, Texas Instruments Incorporated